

BFG590; BFG590/X

NPN 5 GHz wideband transistors

Rev. 04 — 12 November 2007

Product data sheet

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NXP Semiconductors



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NPN 5 GHz wideband transistors

FEATURES

- High power gain
- Low noise figure
- High transition frequency
- Gold metallization ensures excellent reliability.

APPLICATIONS

- MATV/CATV amplifiers and RF communications subscriber equipment in the GHz range
- Ideally suitable for use in class-A, (A)B and C amplifiers with either pulsed or continuous drive.

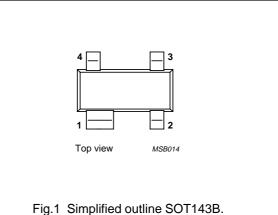
DESCRIPTION

NPN silicon planar epitaxial transistor in a 4-pin dual-emitter SOT143B plastic package.

MARKING

TYPE NUMBER	CODE
BFG590	%MH
BFG590/X	%MN

PIN	DESCRIPTION			
PIN	BFG590	BFG590/X		
1	collector	collector		
2	base	emitter		
3	emitter	base		
4	emitter	emitter		



QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	-	-	20	V
V _{CEO}	collector-emitter voltage	open base	-	-	15	V
I _C	collector current (DC)		-	-	200	mA
P _{tot}	total power dissipation	$T_s \le 60 \ ^{\circ}C$	-	-	400	mW
h _{FE}	DC current gain	I _C = 35 mA; V _{CE} = 8 V	50	90	280	
C _{re}	feedback capacitance	I _C = 0; V _{CE} = 8 V; f = 1 MHz	-	0.7	-	pF
f _T	transition frequency	$I_{C} = 80 \text{ mA}; V_{CE} = 4 \text{ V}; f = 1 \text{ GHz}$	-	5	-	GHz
G _{UM}	maximum unilateral power gain	I _C = 80 mA; V _{CE} = 4 V; f = 900 MHz; T _{amb} = 25 °C	-	13	-	dB
S ₂₁ ²	insertion power gain	I _C = 80 mA; V _{CE} = 4 V; f = 900 MHz; T _{amb} = 25 °C	-	11	-	dB

PINNING

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	-	20	V
V _{CEO}	collector-emitter voltage	open base	-	15	V
V _{EBO}	emitter-base voltage	open collector	-	3	V
I _C	collector current (DC)		-	200	mA
P _{tot}	total power dissipation	$T_s \le 60$ °C; see Fig.2; note 1	-	400	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	175	°C

Note

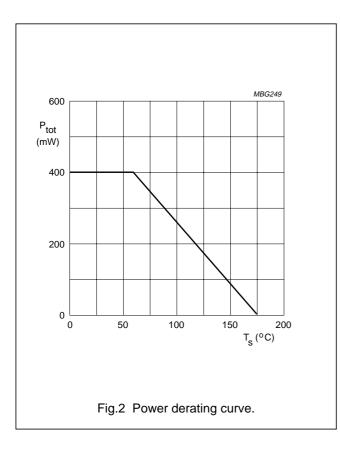
1. T_s is the temperature at the soldering point of the collector pin.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-s}	thermal resistance from junction to soldering point	$T_s \le 60 \ ^{\circ}C$; note 1	290	K/W

Note

1. T_s is the temperature at the soldering point of the collector pin.



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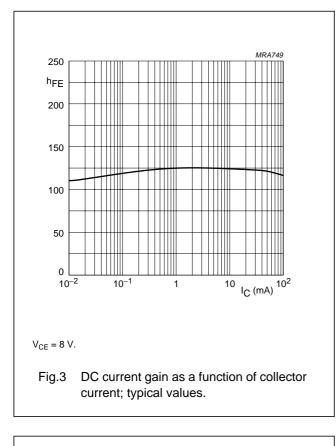
CHARACTERISTICS

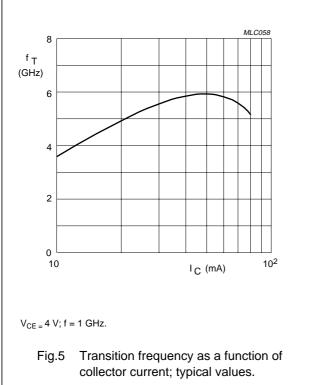
 $T_j = 25 \ ^{\circ}C$ unless otherwise specified.

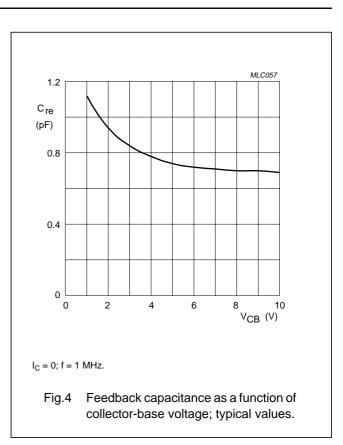
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{(BR)CBO}	collector-base breakdown voltage	$I_{\rm C} = 0.1 \text{ mA}; I_{\rm E} = 0$	20	-	-	V
V _{(BR)CEO}	collector-emitter breakdown voltage	$I_{\rm C} = 10 \text{ mA}; I_{\rm B} = 0$	15	-	-	V
V _{(BR)EBO}	emitter-base breakdown voltage	$I_{E} = 0.1 \text{ mA}; I_{C} = 0$	3	-	-	V
I _{CBO}	collector-base leakage current	$V_{CB} = 10 \text{ V}; I_E = 0$	-	-	100	nA
h _{FE}	DC current gain	$I_C = 70 \text{ mA}; V_{CE} = 8 \text{ V}; \text{ see Fig.3}$	60	120	250	
f _T	transition frequency	I _C = 80 mA; V _{CE} = 4 V; f = 1 GHz; see Fig.5	-	5	-	GHz
C _{re}	feedback capacitance	$I_C = 0$; $V_{CB} = 8$ V; f = 1 MHz; see Fig.4	-	0.7	_	pF
G _{UM}	maximum unilateral power gain; note 1	I _C = 80 mA; V _{CE} = 4 V; f = 900 MHz; T _{amb} = 25 °C	-	13	-	dB
		I_{C} = 80 mA; V_{CE} = 4 V; f = 2 GHz; T_{amb} = 25 °C	-	7.5	-	dB
S ₂₁ ²	insertion power gain	I _C = 80 mA; V _{CE} = 4 V; f = 900 MHz; T _{amb} = 25 °C	-	11	-	dB

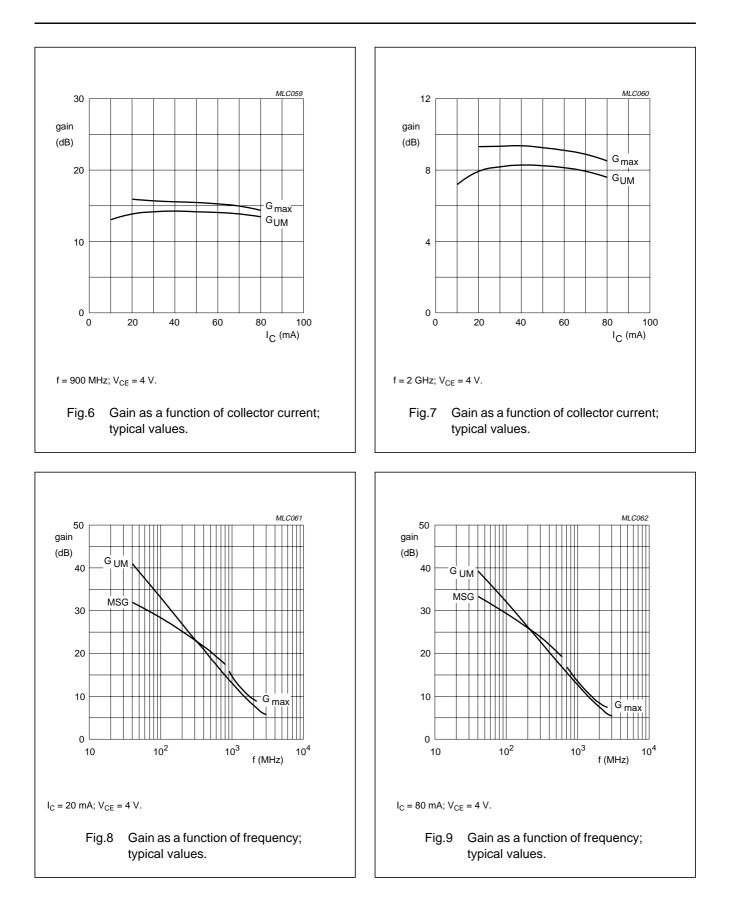
Note

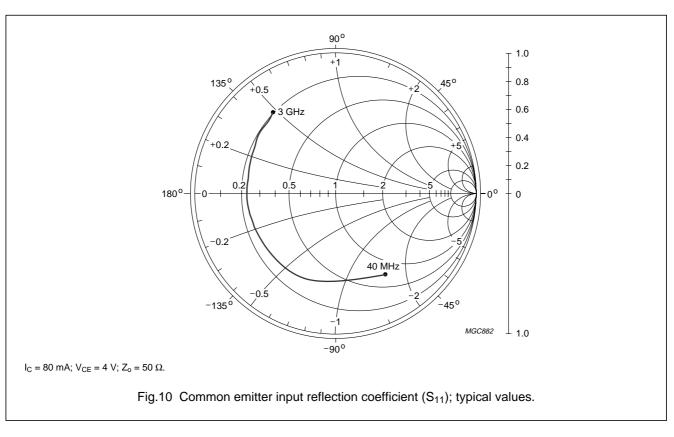
1. G_{UM} is the maximum unilateral power gain, assuming S_{12} is zero and $G_{UM} = 10 \log \frac{|S_{21}|^2}{(1-|S_{11}|^2)(1-|S_{22}|^2)} dB$.

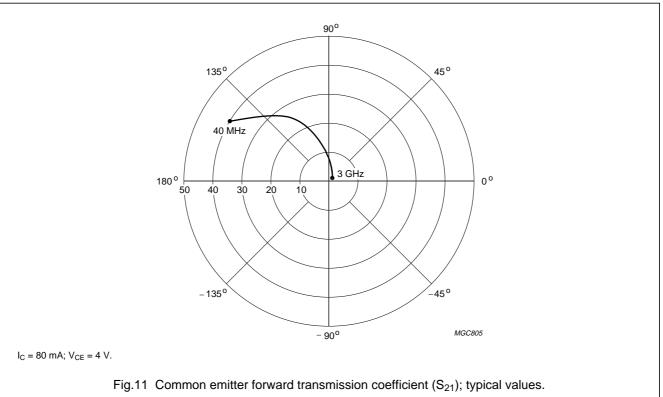


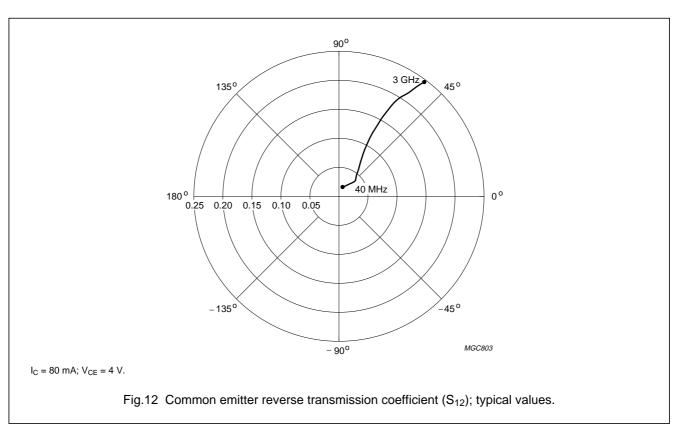


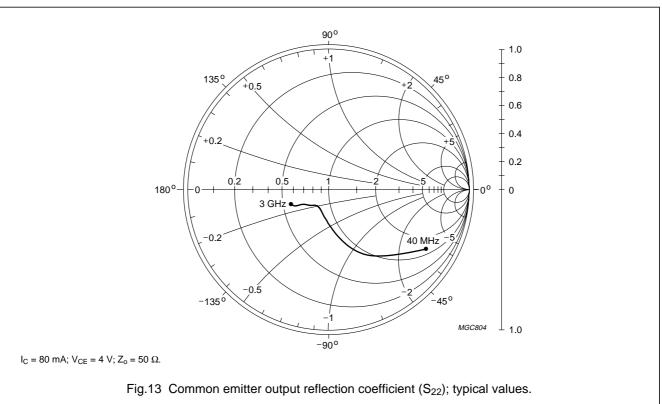






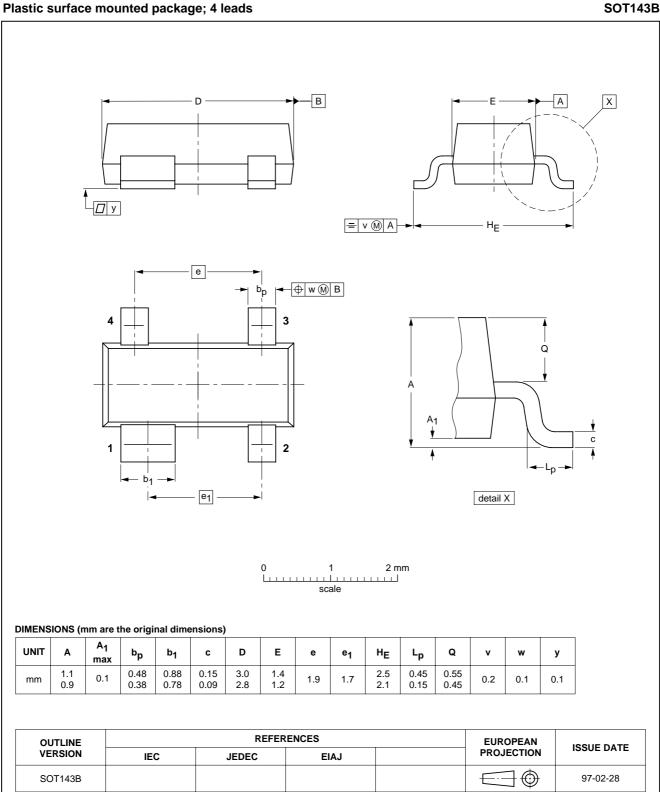






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PACKAGE OUTLINE



Legal information

Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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Revision history

Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes
BFG590_X_N_4	20071112	Product data sheet	-	BFG590_X_3
Modifications:	 Fig. 1 and 2 	on page 2; Figure note chang	ged	
BFG590_X_3 (9397 750 04346)	19981002	Product specification	-	BFG590XR_2
BFG590XR_2	19950919	Product specification	-	BFG590XR_1
BFG590XR_1	19921101	Preliminary specification	-	-

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